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Universal Ascent Holdings Limited

UAM027

Wi-Fi Single-band 1T1R 802.11b/g/n

Module Datasheet

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Revision History.

Version	Date	Revision Content	Draft	Approved
1.0	2023/06/15	New version	Bella	

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1 Overview.

1.1 Introduction.

UAM027 is a cost-effective WIFI+BLE module developed by Uascent Technology, supporting Bluetooth dual mode 5.1 and IEEE 802.11 b/g/n protocol standards, lightweight TCP/IP protocol stack, STA, AP, and Direct modes, and Matter protocol. Users can use this module to add networking functions to existing devices or build independent network controllers.

1.2 Features.

- Operate at ISM frequency bands (2.4GHz).
- Standard IEEE 802.11b/g/n.
- Support WiFi+Bluetooth 5.1.
- Support Wi-Fi and BLE coexist.
- Support BLE assists in fast Wi-Fi connection.
- Built-in low-power 32-bit MCU speed up to 120 MHz, can be used as an application processor.
- Built-in 256KB RAM, 2MB or 4MB internal Flash, 32 bytes eFUSE.
- Built-in lightweight TCP/IP stack.
- Built-in TR switch, BALUN, LNA, PA, and PCB onboard antenna.
- Support remote firmware OTA upgrade, support start upgrade through AT command.
- Support STA and AP and Direct working modes.
- Support WPS/WEP/WPA/WPA2 Personal/WPA2 Enterprise/WPA3 security protocol.

1.3 Recommended Operating Rating.

Description		Min	Typ	Max	Unit
Ambient Temperature (TA)		-40	25	105	deg.C
Vcc		3.0	3.3	3.6	V
(VOL)	Output low voltage	VSS	/	VSS+0.3	V
(VOH)	Output high voltage	VCC-0.3	/	VCC	V

1.4 Reference power consumption for conventional continuous operation.

Parameter	Condition / Notes	Typ.	Unit
TX model			
I _{RF}	11b 11M	270	mA
I _{RF}	11g 54M	260	mA

I_{RF}	11n HT20 MCS7	250	mA
RX model			
I_{RF}	11b 11M	80	mA
I_{RF}	11g 54M	80	mA
I_{RF}	11n HT20 MCS7	80	mA

1.5 ESD Specifications

Item	Description	Value	Unit
Human Body Mode (HBM)	Electrostatic Discharge Tolerance under Human Body Model	± 4	KV
CDM	Electrostatic Discharge Tolerance under Charged Device Model	± 0.2	KV

2 Module usage precautions.

When using the WIFI module of Uascent Technology, a certain tolerance should be reserved for the output current of the power supply. It is recommended that the output current of the power supply be $\geq 500\text{mA}$, and a suitable power supply IC packaging should be selected. When supplying LDO power, attention should be paid to the issue of heating, and when supplying DC-DC power, attention should be paid to the issue of overshoot at the moment of power on.

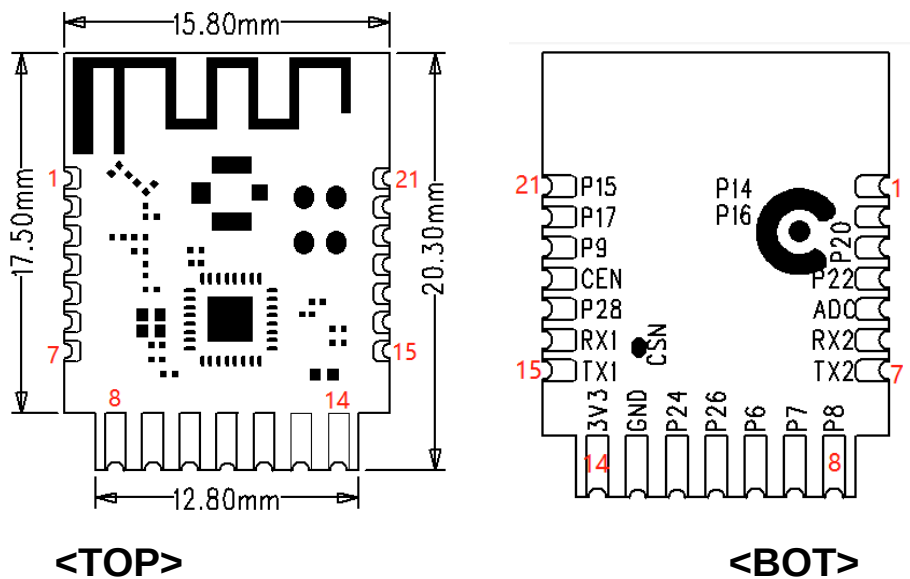
3 WiFi Specification.

Features	Descriptions
Main Chipset	BEKEN : BL2028N
Operating Frequency	2.412~2.484GHz
Operating Voltage	3.0~3.6V
WIFI Standard	IEEE 802.11b/g/n
PHY Data rates	Wi-Fi: 802.11b: 11, 5.5, 2, 1 Mbps 802.11g: 54, 48, 36, 24, 18, 12, 9, 6 Mbps HT20 MCS0-MCS7
Transmit Output Power	Wi-Fi: 802.11b@11Mbps $16\pm 2\text{dBm}$ 802.11g@54Mbps $15\pm 2\text{dBm}$ 802.11n@HT20 MCS7 $14\pm 2\text{dBm}$
EVM	802.11b /11Mbps: $\text{EVM} \leq -10\text{dB}$ 802.11g /54Mbps: $\text{EVM} \leq -25\text{dB}$ 802.11n /HT20 MCS7: $\text{EVM} \leq -27\text{dB}$
Receiver Sensitivity (HT20)	802.11b@8% PER11Mbps $\leq -88\text{dBm}$
	802.11g@10% PER 54Mbps $\leq -74\text{dBm}$

	802.11n@10% PER MCS 7 $\leq$ -71dBm
Operating Channel	Wi-Fi 2.4GHz: 11: (Ch. 1-11) – United States(North America) 13: (Ch. 1-13) – Europe 14: (Ch. 1-14) – Japan
Antenna	PCB onboard antenna

4 Pin Descriptions.

4.1 Pin Outline.



4.2 Pin Definition.

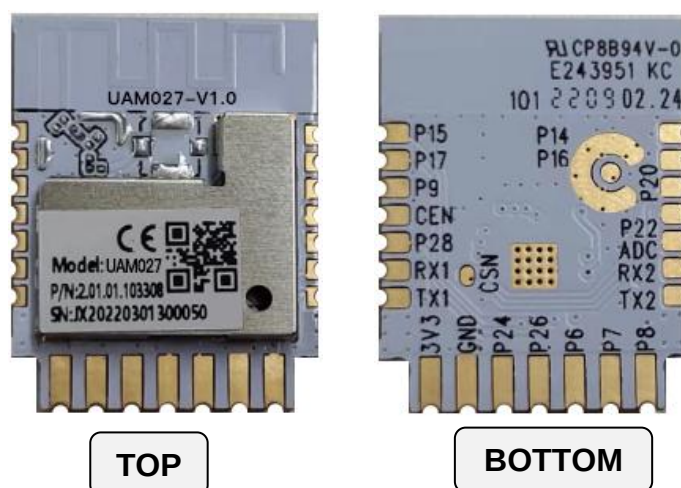
Pin No.	Name	Type	Description	Voltage
1	P14	I/O	GPIO14/ SPI_SCK	
2	P16	I/O	GPIO16/ SPI_MOSI	
3	P20	I/O	GPIO20	
4	P22	I/O	GPIO20	
5	ADC	I	GPIO23/ADC3	
6	RX2	I/O	GPIO1/ RX2	
7	TX2	I/O	GPIO0/TX2	
8	P8	I/O	GPIO8/PWM2	
9	P07	I/O	GPIO7/PWM1	
10	P06	I/O	GPIO6/PWM0	
11	P26	I/O	GPIO26/PWM5	
12	P24	I/O	GPIO24/PWM4	
13	GND	P	Ground	

14	VCC	P	Supply 3.3V	3.3V
15	TX1	I/O	GPIO11/TX1_User data transmission port	
16	RX1	I/O	GPIO10/RX1_User data receiving port	
17	P28	I/O	GPIO28	
18	CEN	I/O	Module reset low effective	
19	P9	I/O	GPIO9/PWM3	
20	P17	I/O	GPIO17/ SPI_MISO	
21	P15	I/O	GPIO15/SPI_CS	

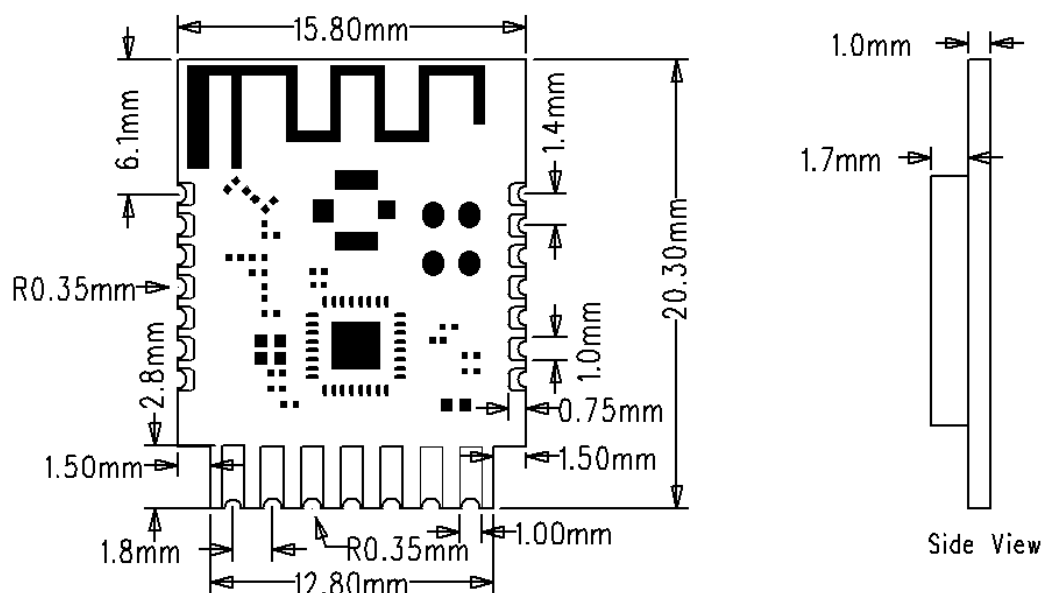
⊗ P:POWER I:INPUT O:OUTPUT

5 Dimensions.

5.1 Module Picture.



L:20.3 x W:15.8 x H:2.7 (± 0.2) unit=mm



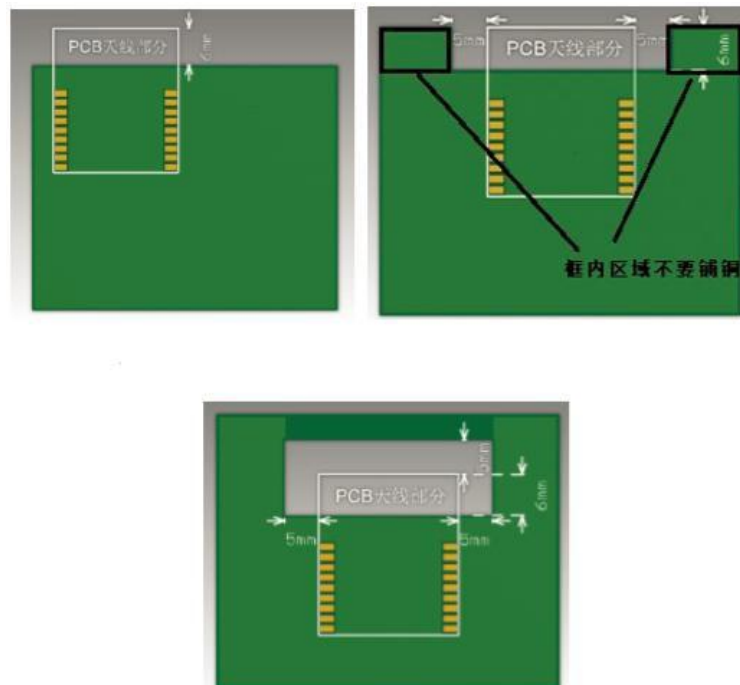
6 Antenna Information.

6.1 Antenna type.

This module antenna type is PCB on-board antenna with antenna gain of -1.3dBi (MAX)

6.2 Module layout considerations.

The UAM027-A0 module shall be welded to the PCB board. In order to obtain the best RF performance. Under the PCB on-board antenna, there should be no copper laying, device and wiring. During PCB design, the corresponding area should be cleared. As shown in the following figure.



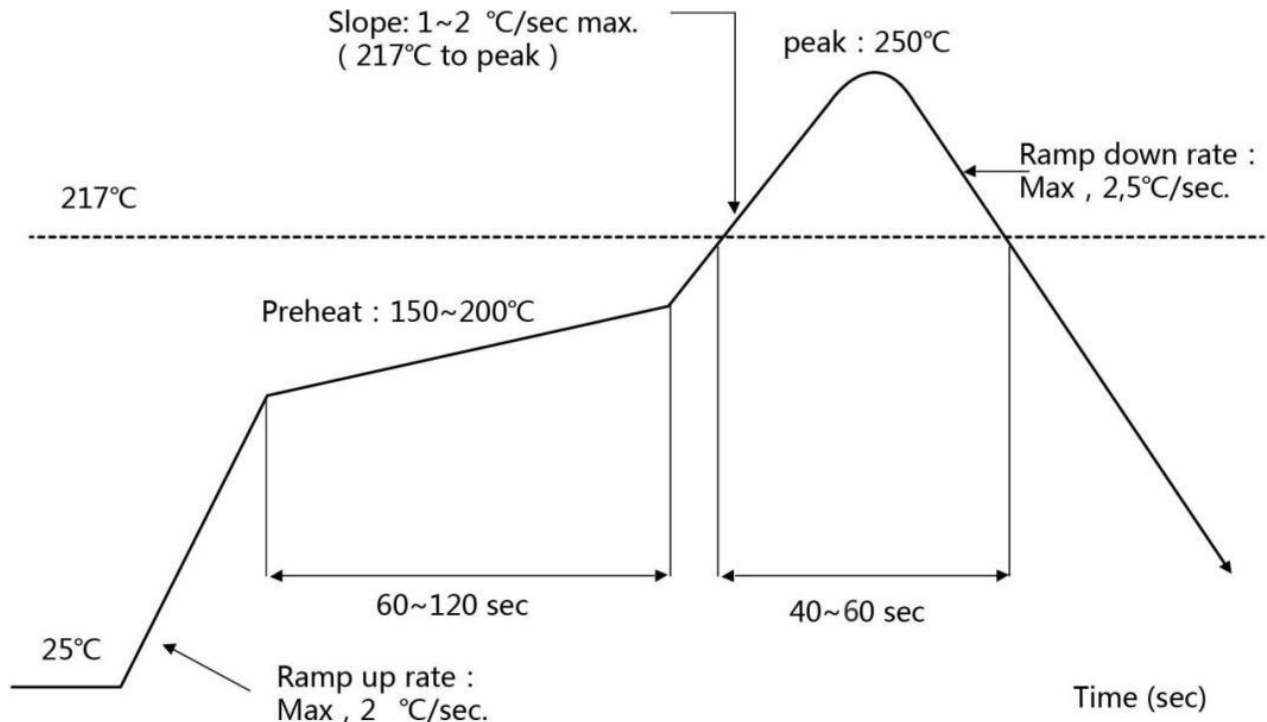
7 Environmental Requirements.

7.1 Recommended Reflow Profile.

Referred to IPC/JEDEC standard.

Peak Temperature : <245°C

Number of Times : ≤2 times



7.2 Note.

Note: Take and use the module, please insure the electrostatic protective measures.

1. Reflow soldering temperature should be according to the customer the main size of the products, such as the temperature set at $250 + 5$ °C for the MID motherboard.

About the module packaging, storage and use of matters needing attention are as follows:

2. The module of the reel and storage life of vacuum packing: 1). Shelf life: 8 months, storage environment conditions: temperature in: < 40 °C, relative humidity: $< 90\%$ r.h.

3. The module vacuum packing once opened, time limit of the assembly:

Card: 1) check the humidity display value should be less than 30% (in blue), such as: 30% ~ 40% (pink), or greater than 40% (red) the module have been moisture absorption. 2.)

factory environmental temperature humidity control: ≤ -30 °C, $\leq 60\%$ r.h..

3). Once opened, the workshop the preservation of life for 168 hours.

4. Once opened, such as when not used up within 168 hours:

1). The module must be again to remove the module moisture absorption.

2). The baking temperature: 125 °C, 8 hours.

3). After baking, put the right amount of desiccant to seal packages.

7.3 Humidity sensitive control.

	CAUTION This bag contains MOISTUR-SENSITIVE DEICES	LEVEL 3 If blank, see adjacent bar code label
1. Calculatied shelf life an sealed bag: 12 months at < 40°C and <90% relative humidity(RH)		
2. Peak package body temperature : _____ 260 _____ °C		
3. After bag is opened ,devices that will be subjected to reflow solder of other high temperature process must a) Mounted within: _____ 168 _____ hrs. of factory confitions ≤30°C/60%RH, OR b) Stored at<10% RH		
4. Devices require bake,before mounting, if: a) Humidity Indicator Care is > 10% when read at 23 ± 5°C b) 3a or 3b not met.		
5. If baking is required , devices may be baked for 48 hrs. at 125 ± 5°C		
Note : If device containers cannot be subjected to high temperature of shorted bake times are desired, reference IPC/JDEC J-STD-033 for bake procedure		
bag Seal Date : _____		
Note : level and body temperature defined by IPC/JEDEC J-STD-020		

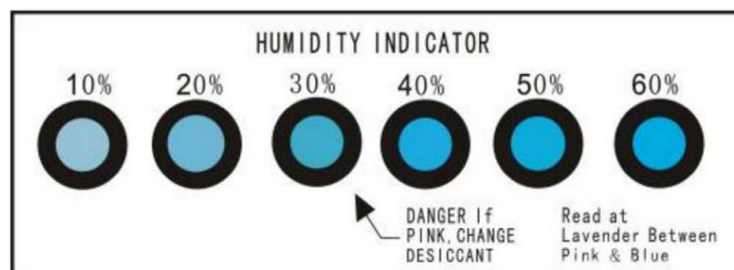
8 Package style.

8.1 Packaging Detail.

The module and the humidity indicator card are placed together in vacuum anti-static packaging, separated by a certain amount of paper, and neatly placed in the packaging box. The packaging must have reliable moisture-proof and anti-collision measures.

Note1:

There is a "triangular arrow" on the humidity indicator card indicating at 30%RH (as shown in the picture below). If the chemical changes to pink in the circle it points to, the element is damp and needs baking.



Note2:

Please confirm the packaging style with our sales staff before purchasing this product. If no packing style is specified before purchase, we will ship the goods by our own choice of packing method.

9 Transport regulations.

In the process of logistics or express transportation, attention should be paid to handling with care to avoid direct rain and snow.

10 Disclaimer and copyright notice.

All information in this document is provided according to the product status quo and subject to change without notice.

The contents of this document disclaim any warranties, including any warranties of fitness for sale, fitness for a particular purpose or non-infringement, and any warranties mentioned elsewhere in any proposal, specification or sample.

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11 Attention.

Due to product version upgrade or other reasons, the content of this manual may be changed. Shenzhen Uascent Technology Co., Ltd. reserves the right to modify the content of this manual without any notice or prompt. If users need to obtain the latest product information, please apply for the final document with our company. This manual is only used as a guide. Shenzhen Uascent Technology Co., Ltd. tries its best to provide the latest information in this manual, but does not guarantee that the content of the manual is completely accurate.

None of the statements, information and recommendations contained in this manual constitute any warranty, express or implied.

12 FCC statements:

This device complies with part 15 of the FCC rules. Operation is subject to the following two conditions:

- (1) this device may not cause harmful interference, and
- (2) this device must accept any interference received, including interference that may cause undesired operation.

NOTE: The manufacturer is not responsible for any radio or TV interference caused by unauthorized modifications or changes to this equipment. Such modifications or changes could void the user's authority to operate the equipment.

The device has been evaluated to meet general RF exposure requirement, The device can be used in mobile condition with 20cm distance between the antenna and human body.

(FCC) Radiation Exposure Statement Power is so low that no RF exposure calculation is needed.

This device is intended only for OEM integrators under the following conditions: 1. The antenna must be installed such that 20 cm is maintained between the antenna and users. 2. The transmitter module may not be co-located with any other transmitter or antenna. As long as the two conditions above are met, additional transmitter testing will not be required. However, the OEM integrator is still responsible for testing their end-product for any additional compliance requirements required for the installed module.

Important Note: In the event that these conditions cannot be met (for example certain laptop configurations or co-location with another transmitter), then the Federal Communications Commission of the U.S. Government (FCC) and the Canadian Government authorizations are no longer considered valid and the FCC ID cannot be used on the final product. In these circumstances, the OEM integrator shall be responsible for re-evaluating the end-product (including the transmitter) and obtaining a separate FCC authorization in the U.S. and Canada. OEM Integrators – End Product Labeling Considerations: This transmitter module is authorized only for use in device where the antenna may be installed such that 20 cm may be maintained between the antenna and users. The final end product must be labeled in a visible area with

the following: " Contains FCC ID: 2A68EJX-UAM027" and Contains IC: 31130-JXUAM027
The grantee's FCC ID can be used only when all FCC compliance requirements are met.
OEM Integrators – End Product Manual Provided to the End User: The OEM integrator shall not provide information to the end user regarding how to install or remove this RF module in end product user manual. The end user manual must include all required regulatory information and warnings as outlined in this document.

This device complies with Industry Canada licence-exempt RSS standard(s).
Operation is subject to the following two conditions: (1) This device may not cause interference, and (2) This device must accept any interference, including interference that may cause undesired operation of the device.

- French:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes:

- (1) l'appareil ne doit pas produire de brouillage, et
- (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.